

RB160M-30,40,60,90

Surface Mount Schottky Barrier Rectifier

Reverse Voltage - 30 to 90

Forward Current - 1.0 A

FEATURES

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: SOD-123FL
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 15mg 0.00048oz

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %



PIN DESCRIPTION 1: Cathode 2: Anode

Simplified outline SOD-123FL and symbol

Parameter	Symbols	RB160M-30	RB160M-40	RB160M-60	RB160M-90	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	30	40	60	90	V
Maximum RMS voltage	V _{RMS}	21	28	42	63	V
Maximum DC Blocking Voltage	V _{DC}	30	40	60	90	V
Maximum Average Forward Rectified Current	I _{F(AV)}	1.0				A
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	40			30	A
Max Instantaneous Forward Voltage at 1 A	V _F	0.55		0.70	0.85	V
Maximum DC Reverse Current T _a = 25°C at Rated DC Reverse Voltage T _a =100°C	I _R	0.3 10			0.2 5	mA
Typical Junction Capacitance ¹⁾	C _j	110	80			pF
Typical Thermal Resistance ²⁾	R _{θJA}	115				°C/W
Operating Junction Temperature Range	T _j	-55 ~ +125				°C
Storage Temperature Range	T _{stg}	-55 ~ +150				°C

1) Measured at 1MHz and applied reverse voltage of 4 V D.C.

2) P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

Fig.1 Forward Characteristic Curve

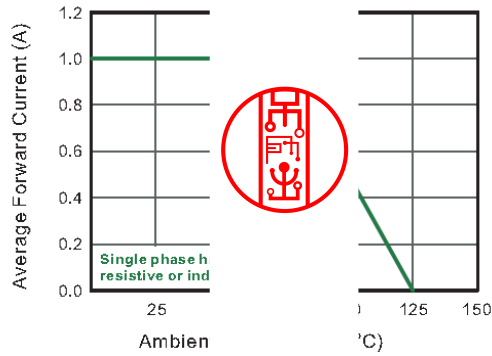


Fig.2 Typical Reverse Characteristics

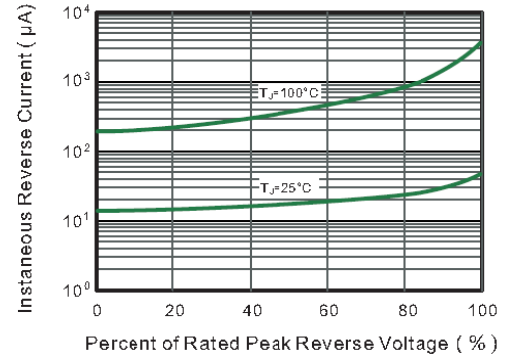


Fig.3 Typical Forward Characteristic

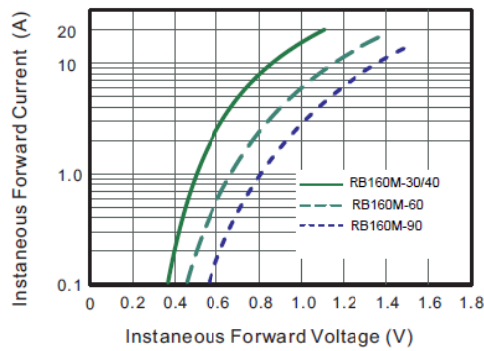


Fig.4 Typical Junction Capacitance

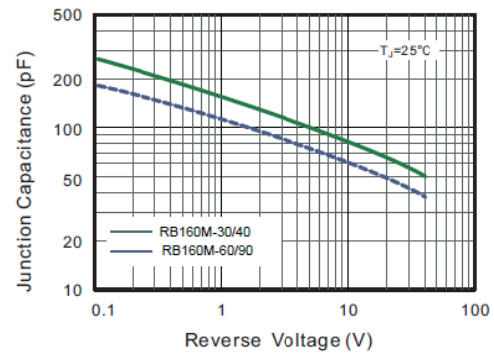


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

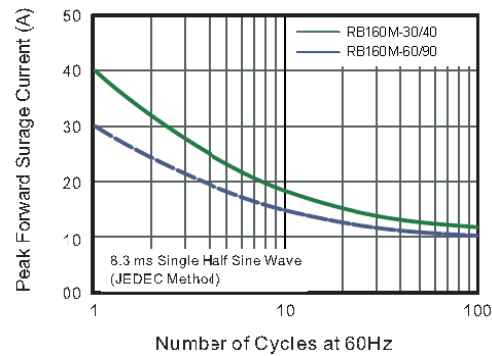
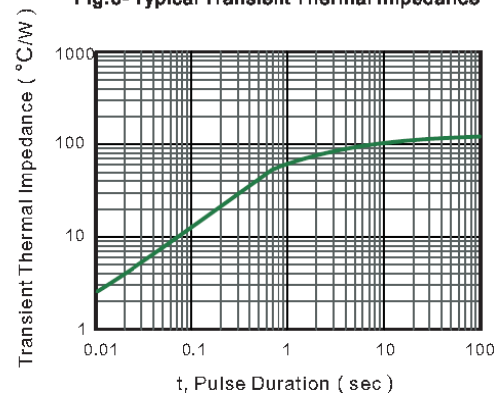


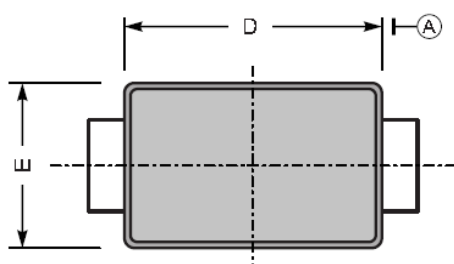
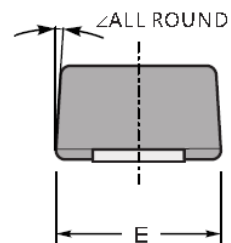
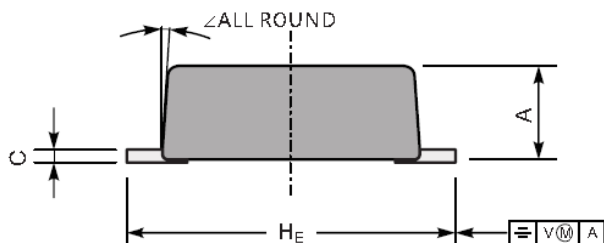
Fig.6- Typical Transient Thermal Impedance



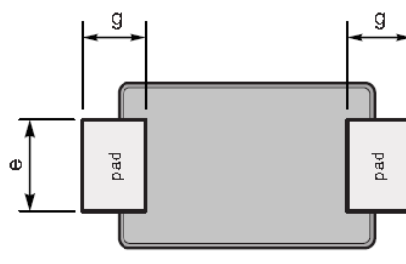
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-123FL



Top View



Bottom View

UNIT		A	C	D	E	e	g	H _E	∠
mm	max	1.1	0.20	2.9	1.9	1.1	0.9	3.8	7°
	min	0.9	0.12	2.6	1.7	0.8	0.7	3.5	
mil	max	43	7.9	114	75	43	35	150	
	min	35	4.7	102	67	31	28	138	

The recommended mounting pad size

